



TDC1035 Monolithic Peak Digitizer 8-Bit, 30ns Full Response Peak Width

Features

- 8-bit resolution
- Full DC linearity for pulses—30ns wide
- Does not require analog peak-hold circuit
- Continuous peak capture between resets
- · Multiple read operations between resets
- 1/2 LSB linearity
- · Narrow ambiguity region around reset
- Detects pulses as small as 12ns wide
- · Guaranteed monotonic
- Selectable data format
- Available in 24-pin CERDIP and 28-lead PLCC packages
- 1.0W power consumption
- Three-state registered outputs

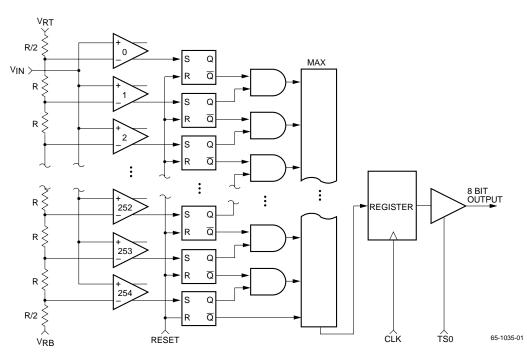
Applications

- Radar pulse classification
- Electronic countermeasures
- Radiation measurement
- Instrumentation

Block Diagram

Description

The TDC1035 is a unique variant of the full-parallel ("flash") analog-to-digital converter, capable of capturing the maximum peak amplitude of one or more pulses applied to its input between asynchronous reset pulses. Multiple "peak read" operations can be performed between resets. Peaks are detected digitally, so operation is stable and predictable. Packaged in a 24-pin CERDIP, the TDC1035 features lower power consumption and smaller size than an analog peak detector/ADC combination. All digital inputs and outputs are TTL compatible, and all outputs are registered and three-state.



Functional Description

General Information

The TDC1035 peak detector operates on ground-referenced negative-going signals. Within tRP nanoseconds after the rising edge of the clock signal CLK, it outputs the most negative value reached since the previous RESET pulse. The active-HIGH RESET control is independent of CLK, but may be connected to CLK to provide a single-control peak detector. Multiple output cycles are permitted between reset operations.

The TDC1035 contains parallel array of comparators, an array of latches, and an encoder which outputs the location of the highest-valued latch which is set. The TDC1035's response characteristics are determined by its comparator array. A comparator's response time is determined by the degree of overdrive, since the output changes only when the area above threshold reaches a characteristic value. Therefore, the digitization accuracy of a pulse's peak value depends on the shape of the pulse.

To permit accurate, repeatable characterization, the TDC1035 is tested with a slew-rate limited "square" pulse. It will digitize (to its DC accuracy) the peak value of a square pulse having a minimum duration of 30ns. The accuracy degrades gracefully as the duration decreases from 30 down to 12ns, where it understates the applied amplitude by 15% (see Figure 5). Production characterization of the TDC1035 uses "square" pulses with controlled rise and fall times of 8ns.

Performance of the TDC1035 with other pulse shapes (such as Gaussian or bandwidth-limited square pulse) can be estimated by applying an energy above threshold model, with area of 120 picoVolt-seconds.

The operation of all asynchronous sequential logic circuits involves some temporal ambiguity. The most common form of this ambiguity, metastability, occurs in data synchronizers. In a peak digitizer such as the TDC1035, this ambiguity comes in the form of periods during which the accuracy of the measurement of a pulse may be affected, or the pulse may not even be detected. There is a 10ns (tRP) ambiguity period after the falling edge of the RESET signal, during which detection or accuracy of detection of any pulse is not guaranteed. There is also a region of 40ns (tPC) before the rising edge of the (output) clock (CLK) where a pulse may be missed or detected inaccurately. These regions are shown in the timing diagrams, Figure 1 and Figure 2. During the latter period, if the input signal increases to a new peak larger than the previously latched value, the value loaded into the output register may be incorrect (and will most likely be zero); nonetheless, the peak detection latches will hold the (correct) new peak value.

As shown in Figure 3, the TDC1035's comparator inputs have emitter-follower buffers, which limit the permissible

input signal slew rate to $250V/\mu s$. This corresponds to a full-scale transition time of 8ns.

Power

The TDC1035 operates from two supply voltages: +5.0V and -5.2V. The current return for the positive supply is D_{GND}, and the return for the negative (analog) supply is A_{GND}. All power and ground pins MUST be connected.

Reference

The reference for the TDC1035 is a negative voltage applied across a chain of 255 resistors. The top of this chain is connected to the RT pin, and the voltage applied to the RT pin (VRT) should be within 0.1V of the analog ground. Note that the difference between the voltage applied to the pin and the voltage at the reference chain is the offset specification (EOT and EOB). The bottom of the reference resistor chain is connected to the RB pin, and the voltage applied to the RB pin (VRB) should be between 1.8 and 2.2V negative with respect to the RT pin for full-specification operation. Reduced reference voltage operation is possible at reduced accuracy (for example, for generating a nonlinear transfer function). The RT–RB reference source should be able to deliver at least 45mA.

Due to the variation in the reference currents with clock and input signals, R_T and R_B should be connected to circuit nodes with a low impedance to ground. For circuits in which the reference is not varied at a high rate, a bypass capacitor to ground is recommended. If the reference inputs are exercised dynamically (e.g., for AGC or nonlinear operation), a low-impedance reference source is required. The reference voltages may be varied dynamically; contact the factory for information on limitations when the device is used in this mode. The performance of the TDC1035 is specified with DC references of $V_{RT} = 0.0V$ and $V_{RB} = -2.0V$.

Control

Two function control pins, $\overline{\text{MINV}}$ and $\overline{\text{LINV}}$, are provided. These names stand for active-LOW Most significant bit INVert and active-LOW Least significant bits INVert, respectively These controls are for DC (i.e., steadystate), not dynamic, use. They permit the output coding to be either straight binary or offset two's complement, in either true or inverted sense, according to the Output Coding Table. A single output state control pin, $\overline{\text{OE}}$, is provided. The three-state outputs may be placed in a high-impedance state by applying a logic HIGH to the $\overline{\text{OE}}$ control pin, and enabled by driving $\overline{\text{OE}}$ LOW.

The function control pins may be tied to V_{CC} for a logic HIGH, and D_{GND} for a logic LOW; however, a 2.2 kOhm pull-up resistor is preferred over direct connection to V_{CC}. If a pull-up resistor is not used, the absolute maximum voltage rating for the part becomes that of the TTL input, 5.5V, rather than the higher value for the V_{CC} terminal.

Command

Two pins, RESET and CLK, control the TDC1035. When brought HIGH, the level-sensitive RESET control resets the peak-storing latches. The edge-sensitive CLK control causes the peak value to be loaded into the output register when a rising-edge (LOW-to-HIGH) signal is applied. As noted above, there is a data ambiguity period associated with the operation of each of these inputs.

Analog Input

Although the TDC1035's 255 comparators have emitterfollower isolated inputs, the input impedance can vary up to 25 percent with the signal level, as comparator input transistors switch on or off. As a result, for optimal performance, the source impedance of the driving device must be less than 25 Ohms. The input signal will not damage the TDC1035 if it remains in the range VEE–0.5V to VAGND+0.5V. If the input signal stays between the V_{RT} and V_{RB} reference voltages, the 8-bit digital equivalent of the most negative voltage reached will be latched into the array of latches, subject to the dynamic effects mentioned above. A transient more negative than V_{RB} will cause a full-scale output t_{DO} after the CLK line rises.

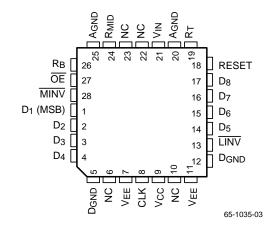
Outputs

The outputs of the TDC1035 are TTL compatible, capable of driving four low-power Schottky TTL (54LS/74LS) unit loads or the equivalent. The outputs hold the previous data a minimum time t_{HO} after the rising edge of the CLK input, and are guaranteed to have the new output value after a maximum time t_{DO}. Under light DC load conditions (such as driving CMOS loads or base-input low-power Schottky such as the 74L5374) 2.2k pull-up resistors to +5.0V are recommended.

Pin Assignments

24 Lead Ceramic DIP						
D1 (MSB) [D2 [D3 [D4 [DGND [VEE [VCC [VCC [VCE [DGND [LINV [D5 [1 2 3 4 5 6 7 8 9 10 11 12	24 23 22 21 20 19 18 17 16 15 14 13		MINV OE RB AGND RMID VIN AGND RT RESET D8 (LSB) D7 D6		
		65-1035-02				

28 Lead PLCC



	Pin Nu	umber		
Pin Name	Ceramic DIP	PLCC	Value	Pin Function Description
Power				
Vcc	8	9	+5.0V	Positive Supply Voltage
VEE	6,9	7,11	-5.2v	Negative Supply Voltage
DGND	5,10	5,12	0.0V	Digital Ground
Agnd	18, 21	20, 25	0.0V	Analog Ground
Reference				
RT	17	19	0.0V	Reference Resistor, Top
RMID	20	24	-1.0V	Reference Resistor, Middle
RB	22	26	-2.0V	Reference Resistor, Bottom
Control			,	
MINV	24	28	TTL (Active LOW)	MSB Invert
LINV	11	13	TTL (Active LOW)	LSB Invert
ŌĒ	23	27	TTL (Active LOW)	Output Enable
Command			,	
RESET	16	18	TTL (Active HIGH)	Resets Peak Value to Zero
CLK	7	8	TTL (Rising Edge)	Loads Output Register
Analog Input			•	
VIN	19	21	0.0V to -2.0V	Analog Input Signal
Outputs			•	
D1	1	1	TTL	MSB Output
D ₂	2	2	TTL	
D3	3	3	TTL	
D4	4	4	TTL	
D5	12	14	TTL	
D ₆	13	15	TTL	
D7	14	16	TTL	
D8	15	17	TTL	LSB Output

Pin Definitions

Absolute Maximum Ratings¹

(beyond which the device may be damaged)

Parameter	Min.	Max.	Unit
Supply Voltages	·		·
V _{CC} (measured to D _{GND})	-0.5	+7.0	V
VEE (measured to DGND)	-7.0	+0.5	V
AGND (measured to DGND)	-0.5	+0.5	V
Input Voltages			
RESET, CLK, OE, MINV, LINV (measured to AGND)	-0.5	+5.5	V
VIN, VRT, VRB (measured to AGND)	VEE - 0.5	+0.5	V
V _{RT} (measured to V _{RB})	-2.2	+2.2	V

Absolute Maximum Ratings¹ (continued)

(beyond which the device may be damaged)

Parameter		Min.	Max.	Unit
Outputs	·			
Applied volt	age (measured to DGND) ²	-0.5	+0.5	V
Applied curr	rent (externally forced) ^{3,4}	-1.0	6.0	mA
Short-circuit	duration (single output HIGH to shorted to ground)		1	Second
Temperatu	re			
Operating	Ambient	-55	+125	°C
	Junction		+175	°C
Lead, solde	ring (10 seconds)		+300	°C
Storage		-65	+150	°C

Notes:

1. Absolute maximum ratings are limiting values applied individually while all other parameters are within specified operating conditions. Functional operation under any of these conditions is NOT implied. Device performance is guaranteed only if specified operating conditions are met.

2. Applied voltage must be current limited to specified range.

3. Forcing voltage must be limited to specified range.

4. Current is specified as positive current flowing into the device.

Operating Conditions

			Т	emperat	ure Rang	ge		
		Standard			Extended			1
Paramete	Parameter		Nom.	Max.	Min.	Nom.	Max.	Units
Vcc	Positive Supply Voltage	4.75	5.0	5.25	4.50	5.0	5.5	V
VEE	Negative Supply Voltage	-4.90	-5.2	-5.5	-4.90	-5.2	-5.5	V
Vagnd	Analog Ground Voltage	-0.1	0.0	0.1	-0.1	0.0	0.1	V
t PWHR	Reset Minimum Pulse Width, HIGH	20			20			ns
tPWLC	CLK Minimum Pulse Width, LOW	20			20			ns
t PWHC	CLK Minimum Pulse Width, HIGH	20			20			ns
SR	Input Signal Slew Rate			250			250	V/µS
VIL	Input Voltage, Logic LOW			0.8			0.8	V
Vih	Input Voltage, Logic HIGH	2.0			2.0			V
IOL	Output Current, Logic LOW			4.0			4.0	mA
ЮН	Output Current, Logic HIGH			-400			-400	μΑ
Vrt	Reterence Voltage, Top	-0.1	0.0	0.1	-0.1	0.0	0.1	V
Vrb	Reference Voltage, Bottom	-1.8	-2.0	-2.2	-1.8	-2.0	-2.2	V
Vrt-	Reference Voltage Span	1.8	2.0	2.2	1.8	2.0	2.2	V
VIN	Input Voltage Range	VRT		Vrb	Vrt		Vrb	V
TA	Ambient Temperature, Still Air	0		70				°C
Тс	Case Temperature				-55		+125	°C

DC Electrical Characteristics

			Temperature Range				
			Stan	dard	Exte	nded	
Param	eter	Test Conditions	Min.	Max.	Min.	Max.	Units
Icc	Positive Supply Current	V _{CC} = Max, Static		35		35	mA
IEE	Negative Supply Current	VEE = Max, Static		-160		-160	mA
IREF	Reference Current	V _{RT} -V _{RB} = Nom		35		35	mA
RREF	Reference Resistance	Total, RT to RB	57		57		Ohms
RIN	Input Equivalent Resistance (DC)	VRT, VRB = Nom, VIN = VRB	50		50		kOhms
CIN	Input Capacitance, Analog	V_{RT} , V_{RB} = Nom, V_{IN} = V_{RB}		50		50	pF
ICB	Input Constant Bias Current	VEE = Max		250		350	μΑ
lı∟	Input Current Logic LOW	$V_{CC} = Max, V_{IL} = 0.4V$		-500		-500	μΑ
Ιн	Input Current Logic HIGH	VCC = Max, VIH = 2.4V		50		50	μΑ
Іім	Input Current, VIN = Max	V _{CC} = Max, V _{IH} = 5.5V		1		1	mA
IOZL	Hi-Z Output Leakage Current, Output LOW	VCC = Max, VO = 0V	-30	30	-30	30	μΑ
Iozh	Hi-Z Output Leakage Current, Output HIGH	V _{CC} = Max, V _O = 5V	-30	30	-30	30	μΑ
los	Short-Circuit Output ¹	V _{CC} = Max, Output HIGH, one output tied to D _{GND} for 1 second.		-50		-50	mA
Vol	Output Voltage, Logic LOW	VCC = Max, IOL = Max		0.5		0.5	V
Vон	Output Voltage, Logic HIGH	V _{CC} = Min, I _{OH} = Max	2.4		2.4		V
CIN	Input Capacitance, Digital			10		10	pF

Note:

1. Worst case all digtal inputs and outputs LOW.

AC Electrical Characteristics

			Temperature Range				
			Stan	Standard Extended		nded	
Paran	neter	Test Conditions	Min.	Max.	Min.	Max.	Units
tPC	CLK Setup Time	V _{CC} = Min, V _{EE} = Min, Load 1		30		30	ns
tRP	RESET Delay	V _{CC} = Min, V _{EE} = Min, Load 1		5		5	ns
tDO	Output Delay	VCC = Min, VEE = Min, Load 1		35		35	ns
tHO	Output Hold Time	V _{CC} = Min, V _{EE} = Min, Load 1	5		5		ns
tDIS	Output Disable Time	VCC = Min, VEE = Min, Load 1		20		20	ns
tENA	Output Enable Time	V _{CC} = Min, V _{EE} = Min, Load 1		70		90	ns

Note:

1. t_{RP} and t_{PC} are the guaranteed maximum lengths of the ambiguity periods.

Timing Diagrams

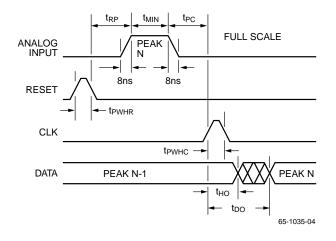


Figure 1. Timing with Separate RESET and CLK

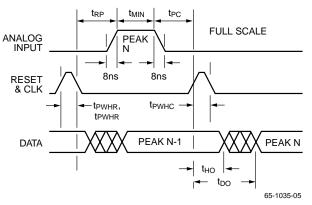


Figure 2. Timing with Common RESET and CLK

			Ten	nperati	ure Ra	nge		
				Standard		Extended		
Param	ieter	Test Conditions		Min.	Max.	Min.	Max.	Units
ELI	Linearity Error, Integral, Independent	V _{RT} , V _{RB} = Nom			0.2		0.2	%FS
ELD	Linearity Error, Differential	VRT, VRB = Nom			0.2		0.2	%FS
CS	Code Size	VRT, VRB = Nom		30	170	30	170	% Nominal
tMIN	Analog Input Pulse	Square Pulse	15% Accuracy	12		12		ns
	Width		DC Accuracy	30		30		ns
Еот	Offset Error, Top	VIN = VRT			±8		±8	mV
Еов	Offset Error, Bottom	VIN = VRB			±15		±15	mV
Тсо	Offset Error, Temperature Coefficent	V _{RT} , V _{RB} , V _{CC} , V _{EE} = Nom			±20		±20	μV/°C

System Performance Characteristics

Equivalent Circuits

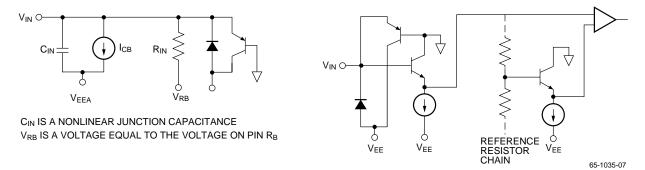


Figure 3. Simplified Analog Input Equivalent Circuits

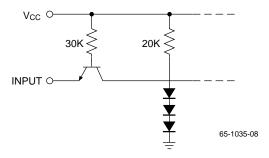


Figure 4. Digital Input Equivalent Circuit

Performance Curve

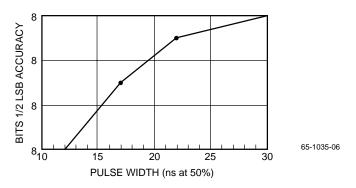


Figure 5. Variation of Accuracy as a Function of Width, "Square" Input Pulse

			Bin	ary	Offset Two's	Complement
	Ran	ge	True	Inverted	True	Inverted
Step	-2.0000V FS 7.8431mV Step	-2.0000V FS 8.000mV Step	MINV = 1 LINV = 1	0 0	0 1	1 0
000	0.0000V	0.0000V	00000000	11111111	1000000	01111111
001	-0.0078V	-0.0080V	00000001	11111110	10000001	01111110
•	•	•	•	•	•	•
•	•	•	•	•	•	•
•	•	•	•	•	•	•
127	-0.9922V	-1.0160V	01111111	10000000	11111111	00000000
128	-1.0000V	-1.0240V	1000000	01111111	00000000	11111111
129	-1.0078V	-1.0320V	10000001	01111110	00000001	11111110
•	•	•	•	•	•	•
•	•	•	•	•	•	•
•	•	•	•	•	•	•
254	-1.9844V	-2.0240V	11111110	00000001	01111110	10000001
255	-1.9922V	-2.0320V	11111111	00000000	01111111	1000000

Output Coding

Applications Discussion

Under certain conditions, the real component of the input impedance may go negative at frequencies near 100MHz. To prevent oscillation at the input signal port, Fairchild recommends connecting the input signal to the TDC1035 via a series-connected resistor of at least 10 Ohms located close to the device. Further, if the signal bandwidth is not already limited so that the input slew rate limit is not exceeded, external circuitry is also recommended. The circuit shown in Figure 7 accomplishes both goals.

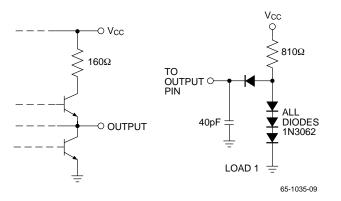


Figure 6. Output Circuits

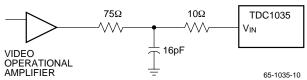


Figure 7. Recommended Input Circuit

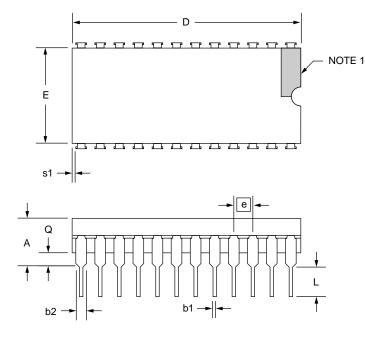
Mechanical Dimensions

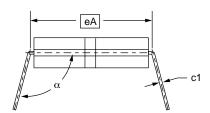
24 Lead Ceramic DIP

Symbol	Inc	hes	Millin	neters	Notes
Symbol	Min.	Max.	Min.	Max.	notes
А		.225	-	5.72	
b1	.014	.023	.36	.58	8
b2	.045	.065	1.14	1.65	2, 8
c1	.008	.015	.20	.38	8
D		1.290		32.77	4
Е	.500	.610	12.70	15.49	4
е	.100	BSC	2.54	BSC	5, 9
eA	.600	BSC	15.24	BSC	7
L	.120	.200	3.05	5.08	
Q	.015	.075	.38	1.91	3
s1	.005	_	.13	_	6
α	90°	105°	90°	105°	

Notes:

- 1. Index area: a notch or a pin one identification mark shall be located adjacent to pin one. The manufacturer's identification shall not be used as pin one identification mark.
- 2. The minimum limit for dimension "b2" may be .023 (.58mm) for leads number 1, 12, 13 and 24 only.
- 3. Dimension "Q" shall be measured from the seating plane to the base plane.
- 4. This dimension allows for off-center lid, meniscus and glass overrun.
- The basic pin spacing is .100 (2.54mm) between centerlines. Each pin centerline shall be located within ±.010 (.25mm) of its exact longitudinal position relative to pins 1 and 24.
- 6. Applies to all four corners (leads number 1, 12, 13, and 24).
- 7. "eA" shall be measured at the center of the lead bends or at the centerline of the leads when " α " is 90°.
- 8. All leads Increase maximum limit by .003 (.08mm) measured at the center of the flat, when lead finish applied.
- 9. Twenty-two spaces.

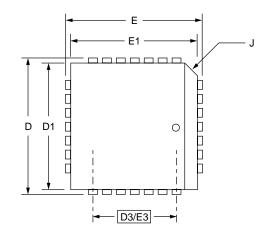


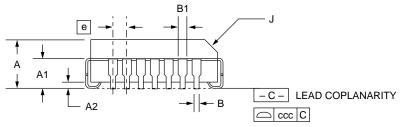


Mechanical Dimensions

28 Lead PLCC

Symbol	Inc	hes	Millin	neters	Notes
Symbol	Min.	Max.	Min.	Max.	Notes
А	.165	.180	4.19	4.57	
A1	.090	.120	2.29	3.05	
A2	.020		.51	_	
В	.013	.021	.33	.53	
B1	.026	.032	.66	.81	
D/E	.485	.495	12.32	12.57	
D1/E1	.450	.456	11.43	11.58	3
D3/E3	.300	BSC	7.62	BSC	
е	.050	BSC	1.27	BSC	
J	.042	.048	1.07	1.22	2
ND/NE	7	7	7		
Ν	2	8	2	28	
CCC	_	.004	_	0.10	





Notes:

- 1. All dimensions and tolerances conform to ANSI Y14.5M-1982
- 2. Corner and edge chamfer (J) = 45°
- Dimension D1 and E1 do not include mold protrusion. Allowable protrusion is .101" (.25mm)

Ordering Information

Product Number	Temperature Range	Screening	Package	Package Marking
TDC1035B7C	STD–T _A = 0°C to 70°C	Commercial	24 Lead Ceramic DIP	1035B7C
TDC1035B7V	EXT–Tc = -55°C to 125°C	MIL-STD-833	24 Lead Ceramic DIP	1035B7V
TDC1035R3C	$T_A = 0^{\circ}C$ to $70^{\circ}C$	Commercial	28 Lead PLCC	1035R3C

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